

Title (en)

HARD MATERIAL SINTERED COMPACT WITH A NICKEL- AND COBALT-FREE, NITROGENOUS STEEL AS BINDER OF THE HARD PHASE

Title (de)

HARTSTOFF-SINTERFORMTEIL MIT EINEM NICKEL- UND KOBALTFREIEN, STICKSTOFFHALTIGEN STAHL ALS BINDER DER HARTSTOFFPHASE

Title (fr)

PIECE MOULEE EN SUBSTANCE DURE COMPORTANT UN ACIER EXEMPT DE NICKEL ET DE COBALT ET CONTENANT DE L'AZOTE, SERVANT DE LIANT DE LA PHASE DE SUBSTANCE DURE

Publication

EP 1144702 A1 20011017 (DE)

Application

EP 99962163 A 19991125

Priority

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Abstract (en)

[origin: US6641640B1] Hard sintered moldings having a nickel- and cobalt-free, nitrogen-containing steel as a binder of the hard phase, processes for the powder metallurgical production of these hard sintered moldings, in particular by powder injection molding, and powder injection molding materials for the production of these hard sintered moldings by powder injection molding.

IPC 1-7

C22C 1/05; C22C 29/06; C23C 8/24

IPC 8 full level

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C22C 29/02 (2006.01); **C22C 29/06** (2006.01); **C22C 29/08** (2006.01); **C22C 29/16** (2006.01); **C23C 8/24** (2006.01)

CPC (source: EP KR US)

B22F 3/225 (2013.01 - EP US); **C22C 1/05** (2013.01 - KR); **C22C 29/067** (2013.01 - EP US); **B22F 2998/00** (2013.01 - EP US);
B22F 2998/10 (2013.01 - EP US); **B22F 2999/00** (2013.01 - EP US)

C-Set (source: EP US)

1. **B22F 2998/00 + B22F 3/225**
2. **B22F 2998/10 + B22F 3/22 + B22F 3/1021 + C23C 8/26**
3. **B22F 2999/00 + C22C 1/051 + B22F 3/22 + B22F 3/1021**

Citation (search report)

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